

Features:

- Phototransistor output
- · High sensitivity
- Low-cost plastic housing
- Available with lenses for dust protection and ambient light filtration
- · Focused for maximum sensitivity



Description:

- The **OPB703**, **OPB704** and **OPB705** consist of an Infrared (890nm) Light Emitting Diode (LED) and a NPN silicon Phototransistor, mounted side-by-side on converging optical axes in a black plastic housing and are designed for PCBoard mounting. The **OPB703WZ**, **OPB704WZ**, **OPB705WZ** and **OPB70BWZ** are designed for remote mounting utilizing interconnect wires of UL approved 26 AWG, 24" (61.0cm) minimum length, stripped and tinned.
- The **OPB70AWZ** consists of an Infrared (890nm) Light Emitting Diode (LED) and a NPN silicon Photodarlington, mounted side-by-side on converging optical axes in a black plastic housing and is designed for remote mounting utilizing interconnect wires of UL approved 26 AWG, 24" (61.0cm) minimum length, stripped and tinned.
- The **OPB70CWZ through OPB70FWZ** consist of a Visible (Red 640nm) Light Emitting Diode (LED) and a NPN silicon Phototransistor or Rbe Phototransistor, mounted side-by-side on converging optical axes in a black plastic housing and are designed for remote mounting utilizing interconnect wires of UL approved 26 AWG, 24" (61.0cm) minimum length, stripped and tinned.
- Various lens options are available: No lens for the (OPB703, OPB703WZ), blue window for dust protection for the (OPB704, OPB704WZ, OPB70BWZ, OPB70HWZ) and aperture lens for improved resolution for the (OPB705, OPB705WZ, OPB70AWZ, OPB70CWZ, OPB70DWZ). The OPB704G and OPB704GWZ offers excellent protection for dirty environments.
- The phototransistor responds to illumination from the emitter when a reflective object passes within the field of view centered typically at 0.15" (3.8 mm).
- Custom electrical, wire, cabling and connectors are available. Contact your local representative or OPTEK for more information.

	Ordering Information							
Applications:	Part	LED Peak	Detector	Optical Cover	Lead or Wire			
 Non-contact reflective object sensor 	OPB703			None	0.160" Leads			
 Assembly line automation 	OPB703WZ			None	24" / 26 AWG Wire			
Machine automation	OPB704				0.160" Leads			
 Machine safety End of travel sensor 	OPB704WZ				24" / 26 AWG Wire			
Door sensor	OPB70HWZ		Transistor	Blue Window	24" / 26 AWG Wire			
Mark Detection	OPB704G	890 nm			0.160" Leads			
Office Equipment	OPB704GWZ				24" / 26 AWG Wire			
Gaming Equipment	OPB705			Aperture	0.160" Leads			
	OPB705WZ							
	OPB70AWZ		Darlington					
	OPB70BWZ		Rbe Transistor	Blue Window				
	OPB70CWZ		Rbe Transistor	Anosturo	24" / 26 AWG Wire			
	OPB70DWZ	640 nm	Transistor	Aperture				
(PYD)	OPB70EWZ	040 1111	Rbe Transistor					
	OPB70FWZ		Transistor	Clear Window				
RoHS OPTEK reserves the right to ma	ake changes at any tin	ne in order to impr	ove design and to sup	oply the best product	possible.			



OPB703, OPB704, OPB705



OPB703WZ, OPB704WZ, OPB705WZ, OPB70AWZ, OPB70BWZ, OPB70CWZ, OPB70DWZ





OPB704G



OPB704GWZ





Absolute	Maximum Ratings (T _A =25°C unless of	therwise	noted)							
Storage	Storage Temperature Range									
Lead S	Lead Soldering Temperature [1/16 inch (1.6 mm) from the case for 5 sec. with soldering iron]									
Input Diode										
Forwar	d DC Current						40 mA			
Revers	e DC Voltage						2 V			
Power	Dissipation						100 mW ⁽²⁾			
Output Ph	otodetector									
Pl Emitte Collec Power Electrical	Collector-Emitter Voltage 30 Phototransistor 31 Emitter-Collector Voltage 11 Collector DC Current 25 Power Dissipation 100 mV Electrical Characteristics (T _A = 25° C unless otherwise noted) 11									
,	OPB703, OPB703WZ, OPB704, OPB704WZ, OPB705, OPB705WZ, OPB704G, OPB704GWZ, OPB70HWZ)									
SYMBOL	SYMBOL PARAMETER MIN TYP MAX UNITS TEST CONDITIONS									
Input Diode	nput Diode (See OP265 for additional information — for reference only)									
V _F	Forward Voltage	-	-	1.7	V	I _F = 40mA				
I _R	Reverse Current	-		100	μA	V _R = 2 V				

Output Phototransistor (See OP505 for additional information — for reference only)

Output Pho	ototransistor (See OP505 for additional inform	ation — to	or retere	nce only)				
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage	30	-	-	V	I _{CE} = 100 μA			
V _{(BR)ECO}	Emitter-Collector Breakdown Voltage	5	-	-	V	I _{EC} = 100μA			
I _{CEO}	Collector Dark Current	-	-	250	nA	V_{CE} = 10 V, I _F = 0, E _E =0			
Coupled	Coupled								
I _{C(ON)}	On-State Collector Current OPB70HWZ OPB703, OPB703WZ OPB704, OPB704WZ OPB705, OPB705WZ	0.60 0.30 0.20 0.15	- - -	3.5 2.5 2.5 1.0	mA	V_{CE} = 5 V, I _F = 40mA , d = 0.15" ⁽³⁾⁽⁷⁾			
	OPB704G, OPB704GWZ	0.50	-	6.0		V_{CE} = 5 V, I_{F} = 40mA , d $$ = 0.20" $^{(3)(6)}$			
I _{cx}	Crosstalk OPB703, OPB703WZ OPB704, OPB704WZ, OPB70HWZ OPB705, OPB705WZ	-	- - -	20 20 10	μΑ	V _{CE} = 5 V, I _F = 40mA ⁽⁶⁾			

Notes:

(1) RMA flux is recommended. Duration can be extended to 10 seconds maximum when flow soldering.

(2) For OPB703, OPB704 and OPB705, derate linearly 1.67 mW/° C above 25° C.

(3) For OPB703WZ, OPB704WZ, OPB705WZ, OPB70BWZ, OPB704G, OPB704GWZ and OPB70HWZ derate linearly 1.82 mW/° C above 25° C.

(4) The distance from the assembly face to the reflective surface is d.

(5) Crosstalk (I_{CX}) is the collector current measured with the indicated current in the input diode and with no reflecting surface.

(6) Measured using Eastman Kodak neutral white test card with 90% diffuse reflectance as a reflecting surface. Reference: Eastman Kodak, Catalog # E 152 7795.



Electrical Characteristics ($T_A = 25^\circ$ C unless otherwise noted)

(OPB70AWZ)

SYMBOL	PARAMETER	MIN	TYP	MAX	UNITS	TEST CONDITIONS			
Input Diod	Input Diode (See OP265 for additional information — for reference only)								
V _F	Forward Voltage	-	-	1.7	V	I _F = 40mA			
I _R	Reverse Current	-	-	100	μA	V _R = 2 V			
Output Ph	otoDarlington (See OP535 for additional	informa	ition — 1	for refer	ence onl	y)			
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage	15	-	-	V	I _{CE} = 1.0 mA, E _E =0			
V _{(BR)ECO}	Emitter-Collector Breakdown Voltage	5	-	-	V	I _{EC} = 100μA, E _E =0			
I _{CEO}	Collector Dark Current	-	-	250	nA	V_{CE} = 10 V, I_{F} = 0, E_{E} =0			
Coupled	Coupled								
I _{C(ON)}	On-State Collector Current	5.0	-	26.0	mA	V_{CE} = 5 V, I_{F} = 40mA , d = 0.15" $^{(2)(5)}$			
V _(SAT)	Saturation Voltage	-	-	1.15	V	I_{C} = 400 $\mu A,I_{F}$ = 40mA , d = 0.15" $^{(2)(5)}$			
I _{CX}	Crosstalk	-	-	25	μA	V_{CE} = 5 V, I _F = 40mA ⁽⁴⁾			

Notes:

(1) RMA flux is recommended. Duration can be extended to 10 seconds maximum when flow soldering.

(2) Derate linearly 1.82 mW/° C above 25° C.

(3) The distance from the assembly face to the reflective surface is d.

(4) Crosstalk (I_{CX}) is the collector current measured with the indicated current in the input diode and with no reflecting surface.

(5) Measured using Eastman Kodak neutral white test card with 90% diffuse reflectance as a reflecting surface. Reference: Eastman Kodak, Catalog # E 152 7795.

(6) All parameters tested using pulse techniques.



Electrical Characteristics (T_A = 25° C unless otherwise noted)

OPB/UBW	Z)									
SYMBOL	PARAMETER	MIN	TYP	MAX	UNITS	TEST CONDITIONS				
nput Diode (See OP265 for additional information — for reference only)										
V _F	Forward Voltage	-	-	1.7	V	I _F = 40mA				
I _R	Reverse Current	-	-	100	μA	V _R = 2 V				
Output Pho	totransistor (See OP705 for additional informa	ation — fe	or refere	nce only)					
$V_{(\text{BR})\text{CEO}}$	Collector-Emitter Breakdown Voltage	30	-	-	V	I _{CE} = 100 μA				
$V_{(BR)ECO}$	Emitter-Collector Breakdown Voltage	0.4	-	-	V	I _{EC} = 100μA				
I _{CEO}	Collector Dark Current	-	-	100	nA	V _{CE} = 10 V, I _F = 0, E _E =0				
Coupled										
I _{C(ON)}	On-State Collector Current OPB70BWZ	0.50	-	3.0	mA	V_{CE} = 5 V, I _F = 40mA , d = 0.15" ⁽³⁾⁽⁶⁾				
I _{CX}	Crosstalk OPB70BWZ	-	-	5	μA	$V_{CE} = 5 \text{ V}, \text{ I}_{\text{F}} = 40 \text{mA}^{(5)}$				

Notes:

(1) RMA flux is recommended. Duration can be extended to 10 seconds maximum when flow soldering.

(2) For OPB703, OPB704 and OPB705, derate linearly 1.67 mW/° C above 25° C.

(3) For OPB703WZ, OPB704WZ, OPB705WZ and OPB70BWZ, derate linearly 1.82 mW/° C above 25° C.

(4) The distance from the assembly face to the reflective surface is d.

(5) Crosstalk (I_{CX}) is the collector current measured with the indicated current in the input diode and with no reflecting surface.

(6) Measured using Eastman Kodak neutral white test card with 90% diffuse reflectance as a reflecting surface. Reference: Eastman Kodak, Catalog # E 152 7795.

(7) All parameters tested using pulse techniques.



Electrical Characteristics (T_A = 25° C unless otherwise noted) (OPB70CWZ and OPB70EWZ)

SYMBOL PARAMETER MIN TYP MAX UNITS **TEST CONDITIONS** Input Diode (See OVLAS6CB8 for additional information — for reference only) V_{F} Forward Voltage 2.6 V $I_F = 40 \text{mA}$ -**Reverse Current** I_R 100 μA V_R = 2 V -Output Phototransistor (See OP505 for additional information - for reference only) Collector-Emitter Breakdown Voltage I_{CE} = 100µA, I_F = 0, E_E =0 30 V V_{(BR)CEO} Emitter-Collector Breakdown Voltage 0.4 V $I_{EC} = 100 \mu A$, $I_F = 0$, $E_E = 0$ V_{(BR)ECO} --Collector Dark Current 100 nA $V_{CE} = 10 \text{ V}, I_F = 0, E_E = 0$ ICEO

Coupled

	On-State Collector Current	OPB70CWZ	.10	-	1.0	m (V_{CE} = 5 V, I _F = 40mA , d = 0.15" ⁽²⁾⁽⁵⁾
I _{C(ON)}	On-State Collector Current	OPB70EWZ	.25	-	2.5	mA	$v_{CE} = 5 v, I_F = 40 \text{ mA}, u = 0.15 \text{ mA}$
V _(SAT)	Saturation Voltage		-	-	0.4	V	I_{C} = 100 $\mu A,I_{F}$ = 40mA , d = 0.15" $^{(2)(5)}$
I _{CX}	Crosstalk		-	-	2	μA	V _{CE} = 5 V, I _F = 40mA ⁽⁴⁾

Notes:

(1) RMA flux is recommended. Duration can be extended to 10 seconds maximum when flow soldering.

(2) For OPB703WZ, OPB704WZ, OPB705WZ and OPB70BWZ, derate linearly 1.82 mW/° C above 25° C.

(3) The distance from the assembly face to the reflective surface is d.

(4) Lower curve is based on a calculated worst-case condition, rather than the conventional -2Ω limit.

(5) Crosstalk (I_{CX}) is the collector current measured with the indicated current in the input diode and with no reflecting surface.
 (6) Measured using Eastman Kodak neutral white test card with 90% diffuse reflectance as a reflecting surface. Reference: Eastman Kodak, Catalog # E 152 7795.

(7) All parameters tested using pulse techniques.



Electrical Characteristics (T_A = 25° C unless otherwise noted) (OPB70DWZ and OPB70FWZ)

SYMBOL MIN TYP MAX UNITS **TEST CONDITIONS** PARAMETER Input Diode (See OVLAS6CB8 for additional information — for reference only) V_{F} Forward Voltage 2.6 V $I_F = 40 \text{mA}$ - I_R **Reverse Current** 100 μA V_R = 2 V --Output Phototransistor (See OP505 for additional information — for reference only) Collector-Emitter Breakdown Voltage 30 V $I_{CE} = 100 \mu A$, $I_F = 0$, $E_E = 0$ V_{(BR)CEO} Emitter-Collector Breakdown Voltage 5.0 V $I_{EC} = 100 \mu A$, $I_F = 0$, $E_E = 0$ V_{(BR)ECO} --250 nA $V_{CE} = 10 \text{ V}, I_F = 0, E_E = 0$ ICEO Collector Dark Current _ _

Coupled

		On-State Collector Current	OPB70DWZ	.10	-	1.5	m (V_{CE} = 5 V, I _F = 40mA , d = 0.15" ⁽²⁾⁽⁵⁾
IC(ON	N)	On-State Collector Current	OPB70FWZ	.25	-	3.5	mA	$v_{CE} = 5 v, I_F = 40 \text{ mA}, u = 0.15 \text{ mA}$
V _{(SA}	T)	Saturation Voltage		-	-	0.4	V	$I_{C(ON)}$ = 100 $\mu A,I_F$ = 40mA , d = 0.15" $^{(2)(5)}$
I _{CX}	(Crosstalk		_	_	5.0	μA	V _{CE} = 5 V, I _F = 40mA ⁽⁴⁾

Notes:

(1) RMA flux is recommended. Duration can be extended to 10 seconds maximum when flow soldering.

(2) For OPB703WZ, OPB704WZ, OPB705WZ and OPB70BWZ, derate linearly 1.82 mW/° C above 25° C.

(3) The distance from the assembly face to the reflective surface is d.

(4) Crosstalk (I_{CX}) is the collector current measured with the indicated current in the input diode and with no reflecting surface.

(5) Measured using Eastman Kodak neutral white test card with 90% diffuse reflectance as a reflecting surface. Reference: Eastman Kodak, Catalog # E 152 7795.

(6) All parameters tested using pulse techniques.





OPB703—Output Distance

OPB704, OPB70B, OPB70H—Output Distance



OPB705, OPB70A, OPB70C, OPB70D—Output Distance







